BCT729XX
Over-Voltage Protection Load Switch with Surge Protection

GENERAL DESCRIPTION

The BCT729XX OVP load switch features surge protection, an internal clamp circuit protects the device from surge voltages up to 110V.

The BCT729XX features an ultra-low 30.7mΩ(Typ.) R_{dson} nFET load switch. When input voltage exceeds the OVP threshold, the switch is turned off very fast to prevent damage to the protected downstream devices. The IN pin is capable of withstanding fault voltages up to $30V_{DC}$.

The default OVP threshold is 5.95V (BCT72901), 6.2V (BCT72902), 6.8V (BCT72905), 9.98V (BCT72909), 10.5V (BCT72910) and 14V (BCT72912), the OVP threshold can be adjusted from 4V to 20V through external OVLO pin.

The device features an open-drain $\overline{ACOK}$ output, when $V_{IN\_UVLO} < V_{IN} < V_{IN\_OVLO}$ and the switch is on, $\overline{ACOK}$ will be driven low to indicate a good power input, otherwise it is high impedance.

This device features over-temperature protection that prevents itself from thermal damaging.

The BCT729XX is available in a RoHS compliant 1.8mm × 1.3mm QFNFC1.8X1.3-12L package.

FEATURES

- Highly reliable 1.8mm × 1.3mm QFNFC1.8X1.3-12L package
- Surge protection
  - IEC 61000-4-5: > 110V
- Integrated low R_{dson} nFET switch: typical 30.7mΩ
- 5A continuous current capability
- Default Over-Voltage Protection (OVP) threshold
  - BCT72901: 5.95V
  - BCT72902: 6.2V
  - BCT72905: 6.8V
  - BCT72909: 9.98V
  - BCT72910: 10.5V
  - BCT72912: 14V
- OVP threshold adjustable range: 4V to 20V
- Input maximum voltage rating: $30V_{DC}$
- Fast turn-off response: typical 50ns
- Over-Temperature Protection (OTP)
- Under-Voltage Lockout (UVLO)

APPLICATIONS

- Smartphones
- Tablets
- Charging Ports

ORDERING INFORMATION

Order Number	Voltage	Package Type	Temperature Range	Marking	QTY/Reel
BCT72901EZC-TR	5.95V	QFNFC1.8x1.3-12L	-40°C to +85°C	901 XXX	3000
BCT72902EZC-TR	6.2V	QFNFC1.8x1.3-12L	-40°C to +85°C	902 XXX	3000

BCT72905EZC-TR	6.8V	QFNFC1.8x1.3-12L	-40°C to +85°C	905 XXX	3000
BCT72909EZC-TR	9.98V	QFNFC1.8x1.3-12L	-40°C to +85°C	909 XXX	3000
BCT72910EZC-TR	10.5V	QFNFC1.8x1.3-12L	-40°C to +85°C	910 XXX	3000
BCT72912EZC-TR	14V	QFNFC1.8x1.3-12L	-40°C to +85°C	912 XXX	3000

"XXX" in Marking will be appeared as the batch code.

PIN CONFIGURATION (TOP VIEW)

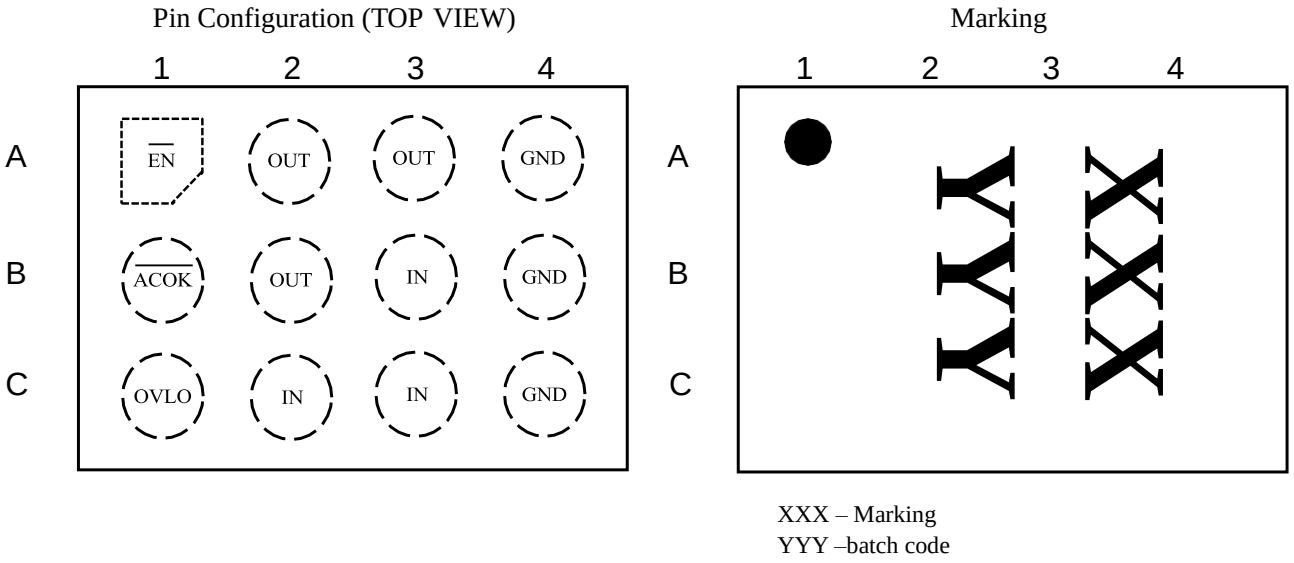


Figure 1 Pin Configuration and Top Mark

PIN DESCRIPTION

BCT729XX

Pin	Name	Function
A1	$\overline{EN}$	Enable pin, active low
B1	$\overline{ACOK}$	Power good flag, active-low, open-drain
C1	OVLO	OVP threshold adjustment pin
C2, C3, B3	IN	Switch input and device power supply
A2, A3, B2	OUT	Switch output
A4, B4, C4	GND	Device ground

FUNCTIONAL BLOCK DIAGRAM

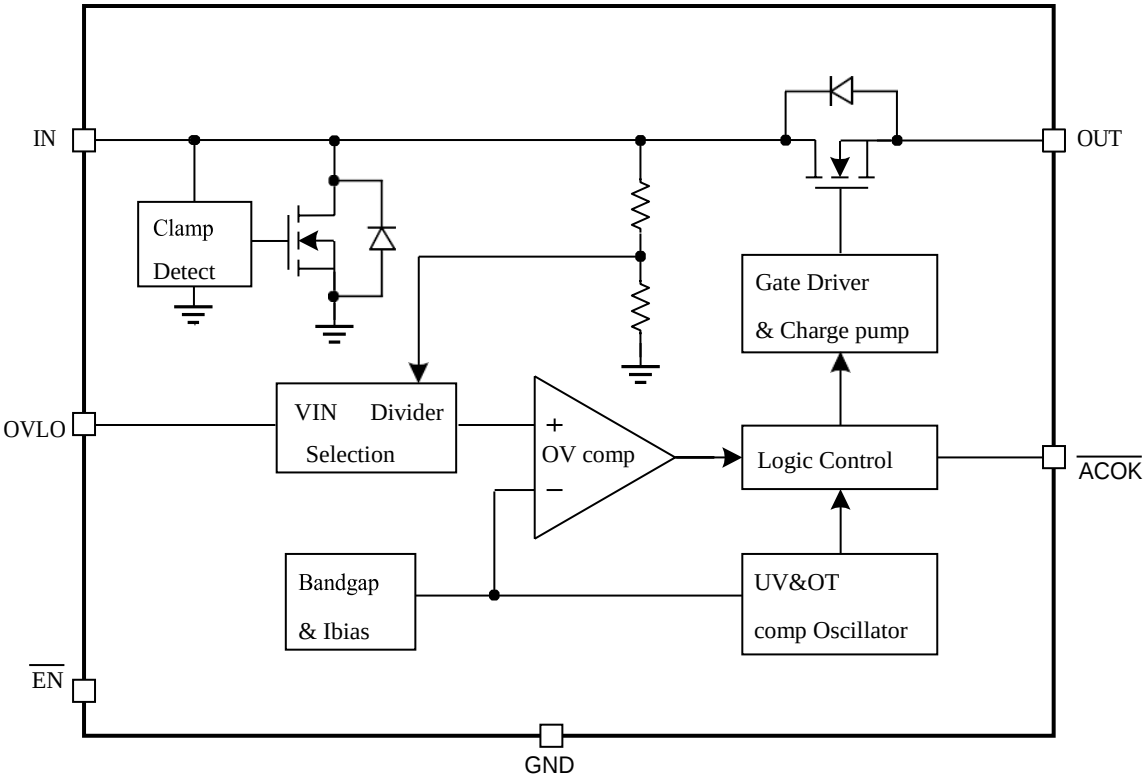


Figure 2 Functional Block Diagram

ABSOLUTE MAXIMUM RATINGS

Supply Voltage (IN to GND) .....-0.3V to 29V
Other Pins(V_{OVLO}/ V_{ACOK} / V_{EN})..... -0.3V to 6V
Out Pin Voltage..... 29V or V_{IN}+0.3V
Continuous Power Dissipation (TA = +70°C)：
QFNFC1.8x1.3-12L (derate 15.4mW/°C above +70°C).....1.23W
Operating Temperature Range .....-40°C to +85°C
Junction Temperature.....+150°C
Storage Temperature Range .....-65°C to +150°C
Lead Temperature (soldering, 10s) .....+260°C
ESD Susceptibility（HBM）.....2KV

Note 1:

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

TA = -40°C to 85°C unless otherwise noted. Typical values are guaranteed for V_{IN} = 5V, C_{IN} = 0.1μF, I_{IN}≤ 5A and TA = 25℃.

参数描述	参数	测试条件		DATASHEET			
				最小	典 型	最大	单位
Input clamp voltage	V_{IN_CLAMP}	I_{IN} = 10mA			30.8		V
Switch on resistance	R_{dson}	V_{IN} = 5V, I_{OUT} = 1A,			30.7		mΩ
Input quiescent current	I_Q	V_{IN} = 5V, V_{OVLO}=0V,I_{OUT} = 0A			65	130	uA
Input current at over-voltage condition	I_{IN_OVLO}	V_{IN} = 5V, V_{OVLO}=3V, V_{OUT} = 0V			60	120	
OVLO set threshold	V_{OVLO_TH}			1.16	1.20	1.24	V
OVP threshold adjustable range	V_{OVLO_RNG}			4		20	
External OVLO select threshold	$O_{VLO\ rising}$			0.19	0.26	0.33	
	Hysteresis				0.06		
OVLO pin leakage current	I_{OVLO}	V_{OVLO}=V_{OVLO_TH}		-0.2		0.2	uA
Protection							
OVP trip level	V_{IN_OVLO}	BCT72901	V_{IN} rising	5.83	5.95	6.07	V
			Hysteresis		0.13		
		BCT72902	V_{IN} rising	6.08	6.20	6.32	
			Hysteresis		0.13		
		BCT72905	V_{IN} rising	6.66	6.80	6.94	
			Hysteresis		0.14		
		BCT72909	V_{IN} rising	9.78	9.98	10.18	
			Hysteresis		0.21		
		BCT72910	V_{IN} rising	10.29	10.50	10.71	
			Hysteresis		0.21		
		BCT72912	V_{IN} rising	13.7	14.0	14.3	
			Hysteresis		0.28		
UVLO trip level	V_{IN_UVLO}	V_{IN} rising			2.9	3.0	
		Hysteresis			0.1		
Shutdown temperature	T_{SDN}				150		℃
Shutdown temperature Hysteresis	T_{SDN_HYS}				20		
Output discharge resistance	R_{DCHG}	V_{OUT}=7V,V_{OVLO}=3V			50		Ω
Digital Logical Interface							
/ACOK output low voltage	V_{OL}	I_{SINK}=1mA			0.4		V
/ACOK leakage current	I_{LEAK_ACOK}	V_{IO}=5V,/ACOK de-asserted		-0.5		0.5	uA

/EN input high voltage	V_{IH}		1.2			V
/EN input low voltage	V_{IL}				0.5	
/EN leakage current	I_{LEAK_EN}	VEN = 5V	0		2	uA
Timing Characteristics						
Debounce time	t_{DEB}	From V_{IN} > V_{IN_UVLO} to 10% V_{OUT}		15		ms
Start-up time	t_{START}	From V_{IN} > V_{IN_UVLO} to ACOK low		30		
Switch turn-on time	t_{ON}	R_L = 100Ω, C_L = 22uF, V_{OUT} from 10% V_{IN} to 90% V_{IN}		2		
Switch turn-off time	t_{OFF}	C_L = 0uF, R_L = 100Ω, V_{IN} > V_{IN_OVLO} to V_{OUT} stop rising, V_{IN} rise at 10V/s		50		ns

TIMING DIAGRAM

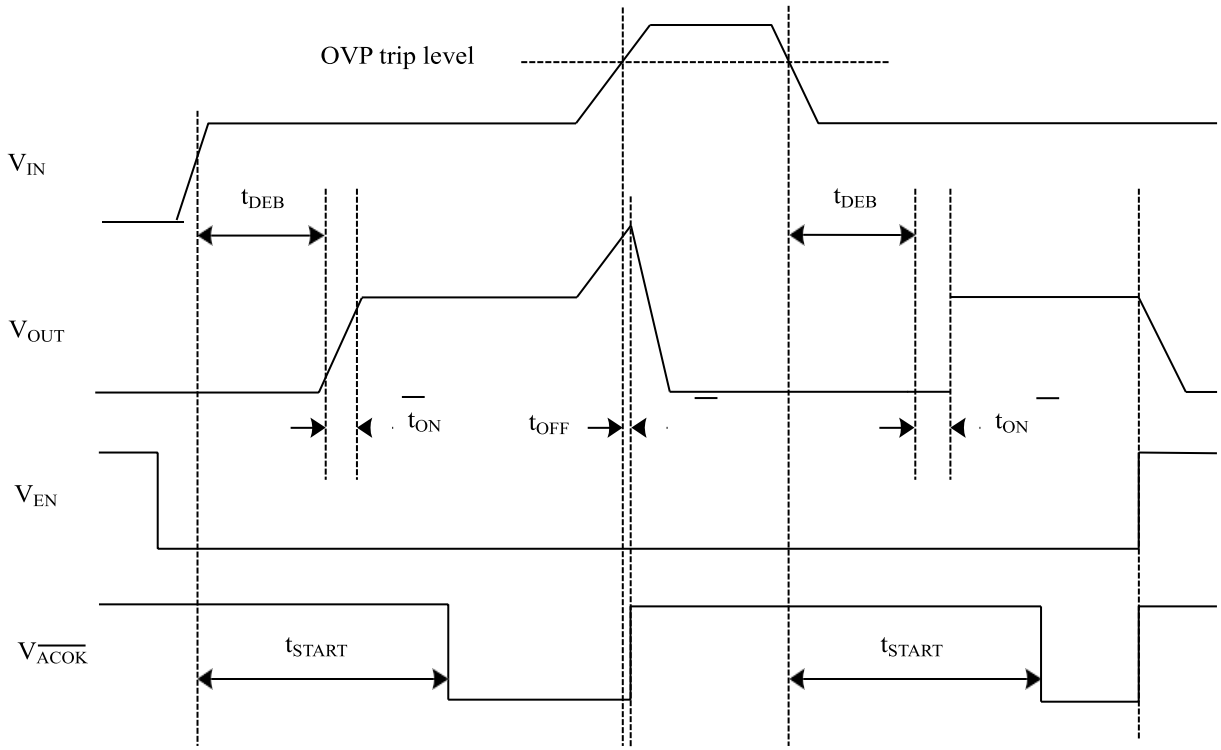


Figure 3 Timing diagram

TYPICAL APPLICATION CIRCUITS

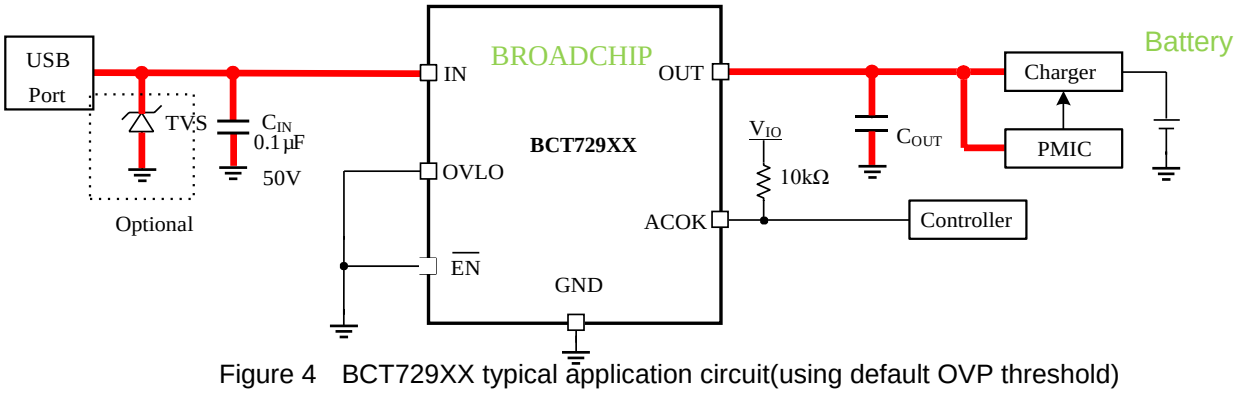


Figure 4 BCT729XX typical application circuit(using default OVP threshold)

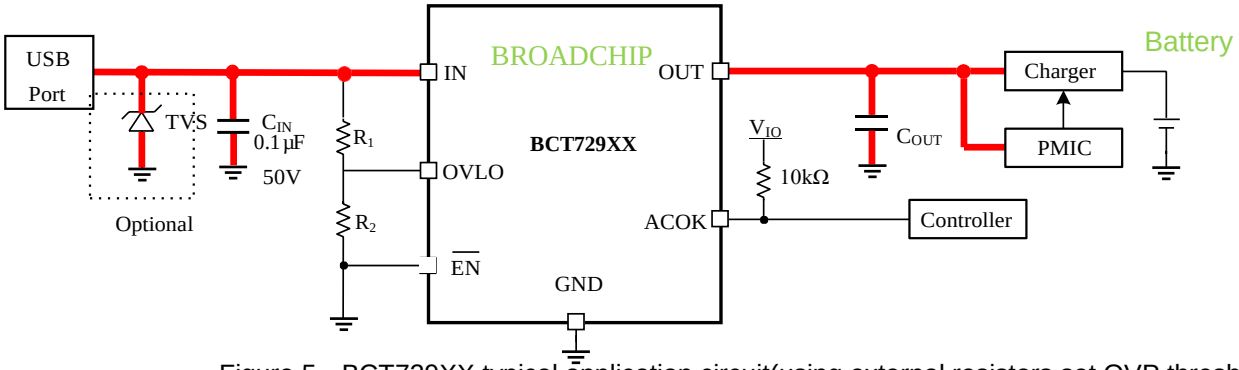


Figure 5 BCT729XX typical application circuit(using external resistors set OVP threshold)

Note:R1 and R2 are used for OVP threshold adjustment, to use default OVP threshold, connect OVLO to ground.

Notice for Typical Application Circuits:

1. If VBUS is required to pass surge voltage greater than 110V, external TVS is needed, the maximum clamping voltage of the TVS should be below 34V.
2. When the default OVP threshold is used, connect OVLO pin to GND directly or through a 0Ω resistor. OVLO pin cannot be left floating.
3. If R1 and R2 are used to adjust the OVP threshold, it is better to use 1% precision resistors to improve the OVP threshold precision.
4. If ACOK is not used, it can be left floating, or short to GND.
5. C_{IN} = 0.1μF is recommended for typical application, larger C_{IN} is also acceptable. The rated voltage of C_{IN} should be larger than the TVS maximum clamping voltage, if no TVS is applied and only BCT729XX is used, the rated voltage of C_{IN} should be 50V.
6. C_{OUT} = 1μF is recommended for typical application, larger C_{OUT} is also acceptable. The rated voltage of C_{OUT} should be larger than the OVP threshold. For example, if the OVP threshold is 5.95V, the rated voltage of C_{OUT} should be 10V or higher.

FUNCTIONAL DESCRIPTION

Device Operation

If the BCT729XX is enabled and the input voltage is between UVLO and OVP threshold, the internal charge pump begins to work after debounce time, the gate of the nFET switch will be slowly charged high till the switch is fully on. $\overline{\text{ACOK}}$ will be driven low about 30ms after V_{IN} valid, indicating the switch is on with a good power input. Ifthe input voltage exceeds the OVP trip level, the switch will be turned off in about 50ns. If EN is $\overline{\text{pulled}}$ high, or input voltage falls below UVLO threshold, or over-temperature happens, the switch will also be turned off.

Surge Protection

The BCT729XX integrates a clamp circuit to suppress input surge voltage. For surge voltages between V_{IN_OVLO} and V_{IN_CLAMP}, the switch will be turned off but the clamp circuit will not work. For surge voltages greater than V_{IN_CLAMP}, the internal clamp circuit will detect surge voltage level and discharge the surge energy to ground. The device can suppress surge voltages up to 110V.

Over-Voltage Protection

If the input voltage exceeds the OVP rising trip level, the switch will be turned off in about 50ns. The switch will remain off until VIN falls below the OVP falling trip level.

OVP Threshold Adjustment

If the default OVP threshold is used, OVLO pin must be grounded. If OVLO pin is not grounded, and by connecting external resistor divider to OVLO pin as shown in the typical application circuit, between IN and GND, the OVP threshold can be adjusted as following:

$$V_{IN\_OVLO} = \frac{R1+R2}{R_2} V_{OVLO\_TH}$$

For example, if we select R_1 = 1MΩ and R_2 = 100kΩ, then the new OVP threshold calculated from the above formula is 13.2V. The OVP threshold adjustment range is from 4V to 20V. When the OVLO pin voltage V_{OVLO} exceeds V_{OVLO_SEL} (0.26V typical), V_{OVLO} is compared with the reference voltage V_{OVLO_TH} (1.2V typical) to judge whether input supply is over-voltage.

$\overline{\text{ACOK}}$ Output

The device features an open-drain output $\overline{\text{ACOK}}$, it should be connected to the system I/O rail through a pull- up resistor. If the device is enabled and $V_{IN\_UVLO} < V_{IN} < V_{IN\_OVLO}$, $\overline{\text{ACOK}}$ will be driven low indicating the switch is on with a good power input. If OVP, UVLO, or OT occurs, or $\overline{\text{EN}}$ is pulled high, the switch will be turned off and $\overline{\text{ACOK}}$ will be pulled high.

USB On-The-Go (OTG) Operation

If V_{IN} = 0V and OUT is supplied by OTG voltage, the body diode of the load switch conducts current from OUT to IN and the voltage drop from OUT to IN is approximately 0.7V. When $V_{IN} > V_{IN\_UVLO}$, internal charge pump begins to open the load switch after debounce time (about 15ms). After switch is fully on, current is supplied through switch channel and the voltage drop from OUT to IN is minimum.

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Min.	Typ.	Max.	Unit
V_{IN}	Input DC voltage	3		28	V
C_{IN}	Input capacitance		0.1		μF
C_{OUT}	Output load capacitance		1		μF

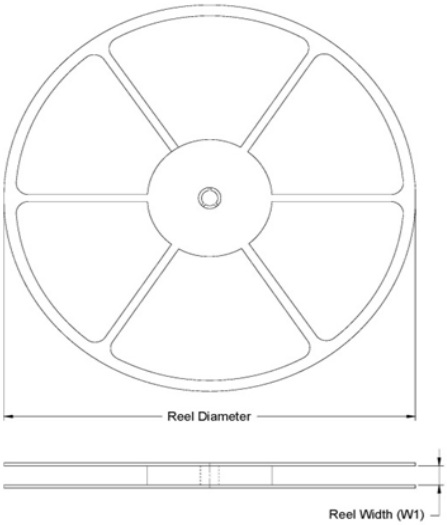
PCB LAYOUT CONSIDERATION

To make fully use of the performance of BCT729XX, the guidelines below should be followed.

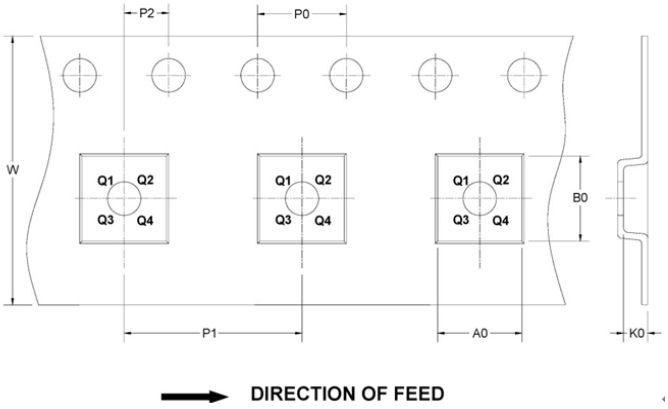
1. All the peripherals should be placed as close to the device as possible. Place the input capacitor C_{IN} on the top layer (same layer as the BCT729XX) and close to IN pin, and place the output capacitor C_{OUT} on the top layer (same layer as the BCT729XX) and close to OUT pin.
2. If external TVS is used, IN pin routing passes through the external TVS firstly, and then connect BCT729XX.
3. Red bold paths on figure 4 and 5 are power lines that will flow large current, please route them on PCB as straight, wide and short as possible.
4. If R1 and R2 are used, route OVLO line on PCB as short as possible to reduce parasitic capacitance.
5. The power trace from USB connector to BCT729XX may suffer from ESD event, keep other traces away from it to minimize possible EMI and ESD coupling.
6. Use rounded corners on the power trace from USB connector to BCT729XX to decrease EMI coupling.

TAPE AND REEL INFORMATION

REEL DIMENSIONS



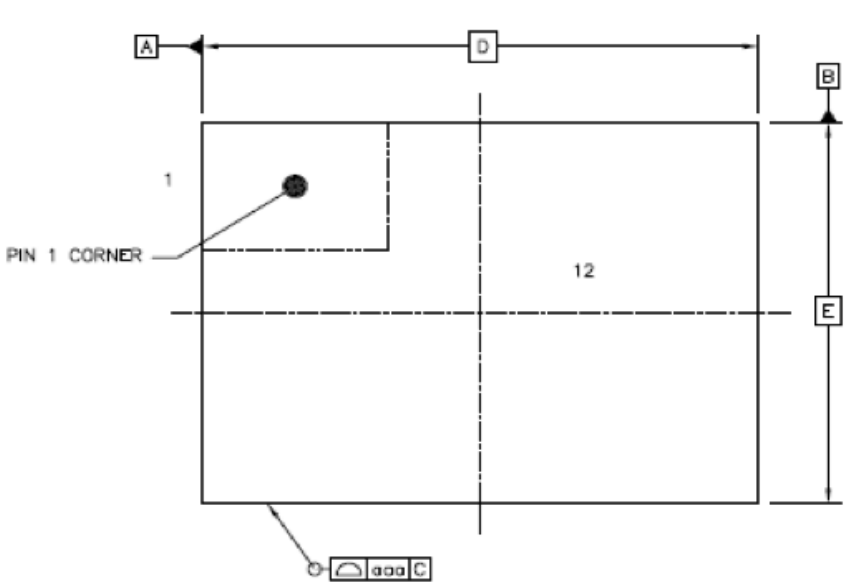
TAPE DIMENSIONS



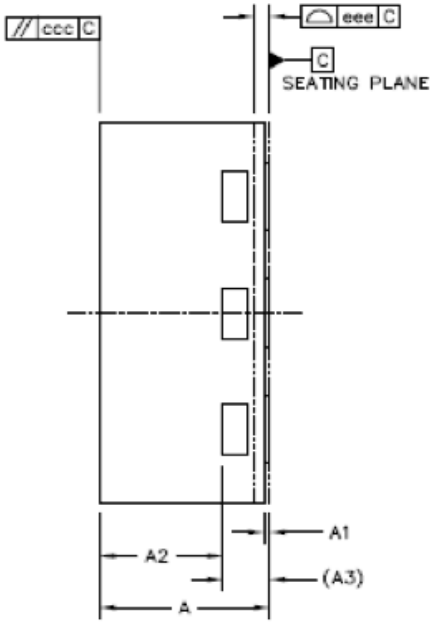
Reel Diameter	Unit: mm								Pin 1 Quadrant	Reel Q'ty
	Reel Width W1	A0	B0	K0	P0	P1	P2	W		
7"	9.5	1.5	2.02	0.74	4	4	2	8	Q2	3000

PACKAGE OUTLINE DIMENSIONS

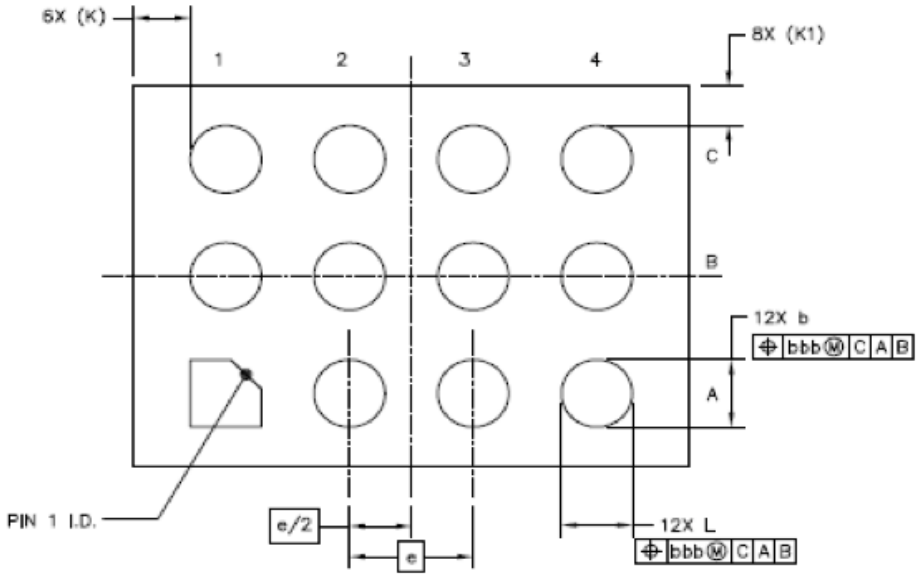
QFNFC1.8X1.3-12L



TOP VIEW



SIDE VIEW



BOTTOM VIEW

Symbol	Dimensions In Millimeters		
	Min	Nom	Max
A	0.5	0.55	0.6
A1	0	0.02	0.05
A2	---	0.4	---
A3	0.152REF		
b	0.18	0.23	0.28
D	1.8(BSC)		
E	1.3(BSC)		
e	0.4(BSC)		
L	0.18	0.23	0.28
K	0.185REF		
K1	0.135REF		
aaa	0.1		
ccc	0.1		
eee	0.05		
bbb	0.07		

QFNFC1.8X1.3-12L Surface Mount Package